L Number	Hits		DB	Time stamp
1	2077	(flexible same (board or substrate)) and dies	USPAT;	2004/08/19 10:29
			EPO; JPO;	
			DERWENT;	
_			USOCR	
2	56	(flexible same (board or substrate)) and dies and	USPAT;	2004/08/19 09:52
		overmold\$3	EPO; JPO;	
			DERWENT;	
			USOCR	
3	15929	BGA or (ball adj grid adj array)	USPAT;	2004/08/19 10:03
			EPO; JPO;	,
			DERWENT;	
			USOCR	
5	40	((flexible same (board or substrate)) and dies and	USPAT;	2004/08/19 10:18
		overmold\$3) and (BGA or (ball adj grid adj array))	EPO; JPO;	
			DERWENT;	
			USOCR	
6	3	("4980219" "4981817" "5182851").PN.	USPAT	2004/08/19 10:05
7	4	("3766439" "5117282" "5313416" "5335145").PN.	USPAT	2004/08/19 10:06
8	33	5448511.URPN.	USPAT	2004/08/19 10:06
9	17	("3341742" "3454911" "4426689" "4781601"	USPAT	2004/08/19 10:08
		"5179501" "5220488" "5252857" "5345205"	••••	2004/00/10 10:00
		"5382829" "5448511" "5451774" "5452182"		
		"5519578" "5544015" "5634194" "5747743"		
		"5767824").PN.		
10	13	("3152288" "3248779" "3766439" "3873889"	USPAT	2004/08/19 10:09
		"3971127" "4490721" "4495546" "4591814"	00.71	2004/00/15 10:05
		"4716259" "4792879" "4816836" "4967201"		
		"5005019").PN.		
11	19	5345205.URPN.	USPAT	2004/08/19 10:10
12	7	("5117282" "5170328" "5345205" "5776797"	USPAT	2004/08/19 10:10
	•	"6014316" "6172418" "6208521"	USFAI	2004/00/19 10:11
		"2001/0015487").PN.		
13	20	("3242384" "3873889" "4991290" "5008496"	USPAT	2004/08/19 10:12
,0	20	"5220488" "5224023" "5252857" "5265322"	USPAT	2004/06/19 10:12
		"5345205" "5386341" "5448511" "5519578"		
		3343203 3386341 3448311 3519576 "5565705" "5646446" "5717556" "5789815"		
İ		"5805422" "5926369" "5956234" "5963427").PN.		
14	4	("4066851" "4402135" "4710419" "4772496").PN.	LICOAT	0004/00/40 40 44
15	29	(4000051 4402135 4710419 4772496").PN. 5008496.URPN.	USPAT	2004/08/19 10:14
16	169		USPAT	2004/08/19 10:14
10	109	dies and overmold\$3	USPAT;	2004/08/19 10:19
			EPO; JPO;	
			DERWENT;	
47	46	diag and averaged \$2 and never	USOCR	
17	46	dies and overmold\$3 and rows	USPAT;	2004/08/19 10:19
			EPO; JPO;	
			DERWENT;	1
40		/ P	USOCR	
18	45	(dies and overmold\$3 and rows) and (board or	USPAT;	2004/08/19 10:19
		substrate)	EPO; JPO;	
		·	DERWENT;	
			USOCR	
19	27	((dies and overmold\$3 and rows) and (board or	USPAT;	2004/08/19 10:23
		substrate)) and (BGA or (ball adj grid adj array))	EPO; JPO;	
			DERWENT;	
			USOCR	
20	27	257/787-790.ccls. and (flexible and overmold\$3)	USPAT;	2004/08/19 10:26
l			EPO; JPO;	
			DERWENT;	
			USOCR	
21	7	("5397917" "6075710" "6150724" "6252301"	USPAT	2004/08/19 10:25
		"6287890" "6339254" "6521485").PN.		
22	9	174/52.2.ccls. and (flexible and overmold\$3)	USPAT;	2004/08/19 10:27
	ļ	•	EPO; JPO;	
ı				1
			DERWENT;	

23	7	174/254.ccls. and (flexible and overmold\$3)	USPAT;	2004/08/19 10:27
			EPO; JPO;	
			DERWENT;	
	40	474/000 000 4 4/5 114 4 4 4 4 4	USOCR	
24	13	174/260-263.ccls. and (flexible and overmold\$3)	USPAT;	2004/08/19 10:28
			EPO; JPO;	
			DERWENT;	•
			USOCR	
25	12	361/760-764.ccls. and (flexible and overmold\$3)	USPAT;	2004/08/19 10:29
			EPO; JPO;	
			DERWENT;	
			USOCR	
26	5	438/123.ccls. and (flexible and overmold\$3)	USPAT;	2004/08/19 10:29
			EPO; JPO;	1
			DERWENT:	
			USOCR	
27	3225	BGA adj package	USPAT;	2004/08/19 10:29
			EPO; JPO;	
			DERWENT;	
			USOCR	
28	13594	(flexible same (board or substrate)) and fold\$3	USPAT;	2004/08/19 10:30
		(EPO; JPO;	200 1100/10 10:00
			DERWENT;	
			USOCR	
29	10	(BGA adj package) and ((flexible same (board or	USPAT;	2004/08/19 10:32
		substrate)) and fold\$3)	EPO; JPO;	2004/00/13 10.52
			DERWENT;	
			USOCR	
30	3029	printed adj circuit adj substrate	USPAT;	2004/08/19 10:32
-		printed day on our day outsour ato	EPO; JPO;	2004/00/19 10.5/
			DERWENT;	
			USOCR	
31	124	(printed adj circuit adj substrate) and fold\$3	USPAT;	2004/08/19 10:32
	,	(printed adj on odit adj substrate) and foldeo	EPO; JPO;	2004/06/19 10:5/
			DERWENT;	
			USOCR	
32	15	((printed adj circuit adj substrate) and fold\$3) and		2004/08/19 10:34
	13	(encapsulat\$3 or overmold\$3)	USPAT;	2004/08/19 10:34
		(encapsulates of overmologs)	EPO; JPO;	
			DERWENT;	
33	0	minotio adi avamaldina	USOCR	0004/00/40
33		plastic adj overnolding	USPAT;	2004/08/19 10:34
			EPO; JPO;	
			DERWENT;	
24	47		USOCR	
34	47	plastic adj overmolding	USPAT;	2004/08/19 10:34
			EPO; JPO;	
			DERWENT;	
25	10	(-1-A)A)A)	USOCR	1
35	12	(plastic adj overmolding) and (board or substrate)	USPAT;	2004/08/19 10:34
			EPO; JPO;	
			DERWENT;	
			USOCR	1